

### **General-purpose Operational Amplifiers / Comparators**

# SIGNATURE SERIES **Operational Amplifiers**





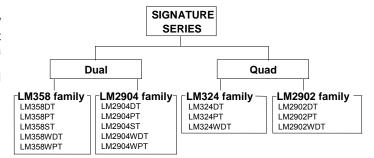
LM358DT/PT/ST/WDT/WPT.LM2904DT/PT/ST/WDT/WPT LM324DT/PT/WDT,LM2902DT/PT/WDT

No.15094ECT05

### Description

The Universal Standard family LM358 / 324, LM2904 / 2902 monolithic ICs integrate two independent op-amps and phase compensation capacitors on a single chip

and feature high-gain, low power consumption, and an operating voltage range of 3[V] to 32[V] (single power supply.)



#### Features

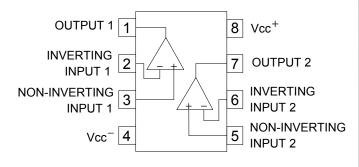
1) Operating temperature range

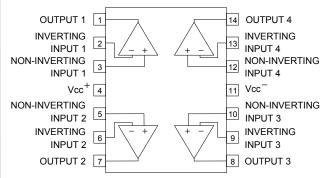
Commercial Grade LM358/324 family 0[°C] to + 70[°C] Extended Industrial Grade LM2904/2902 family: -40[°C] to +125[°C]

2) Wide operating supply voltage +3[V] to +32[V] (single supply)  $\pm 1.5[V]$  to  $\pm 16[V]$  (dual supply)

- 3) Low supply current
- Common-mode input voltage range including ground
- Differential input voltage range equal to maximum rated supply voltage
- High large signal voltage gain
- Wide output voltage range

### Pin Assignment





## SO package8

## TSSOP8

### Mini SO8

LM358ST

LM2904ST

LM324DT

LM2902DT LM2902WDT

LM324WDT

### SO package14

LM324PT LM2902PT

TSSOP14

LM358WDT	
LM2904DT	
LM2904WDT	

LM358DT

LM358PT I M358WPT LM2904PT LM2904WPT ● Absolute Maximum Ratings (Ta=25[°C])

Parameter	Symbol		Ra	ting		Unit		
Farameter	Syllibol	LM358 family LM324 family LM2904		LM2904 family	LM2902 family	Offic		
Supply Voltage	VDD	+32						
Operating Temperature Range	Topr	0 to +70 -40 to +125						
Storage Temperature Range	Tstg		-65 to +150					
Input Common-mode Voltage	VICM	-0.3 to +32						
Maximum Junction Temperature	Tjmax	+150						

### **●**Electric Characteristics

OLM358,LM324 family(Unless otherwise specified, Vcc<sup>+</sup>=+5[V], Vcc<sup>-</sup>=0[V])

		Towns			Lin	nit					
Parameter	Symbol	Temperature range	LN	//358 fan	nily	LN	//324 fam	nily	Unit	Conditions	Fig. No
			Min.	Тур.	Max.	Min.	Тур.	Max.			
Input Offset Voltage (*1)	VIO	25°C	-	2	7	-	-	7	mV	VO=1.4[V],RS=0[Ω] 5[V]< Vcc <sup>+</sup> <30[V]	98
		Full range	-	_	9	_	_	9		0 <vic< vcc<sup="">+-1.5[V]</vic<>	
Input Offset Current (*1)	IIO	25°C	-	2	30	_	2	30	nA	VO=1.4[V]	98
		Full range	-	-	450		-	100			
Input Bias Current (*1)	IIB	25°C Full range	-	20	150 200		20	150 300	nA	VO=1.4[V]	98
Large Signal Voltage Gain	AVD	25°C	25	100	_	25	100	_	V/mV	Vcc <sup>+</sup> =15[V] VO=1.4[V] to 11.4[V]	98
		25°C	65	100	_	65	110	_		RL=2[kΩ] RS≦10[kΩ]	
Supply Voltage Rejection Ratio	SVR	Full range	65	_	_	65	_	_	dB	Vcc <sup>+</sup> =5[V] to 30[V]	98
		25°C	_	_	_	_	0.7	1.2		Vcc <sup>+</sup> =5[V],No Load	
0 1 - 0 1 (All A )	100	25°C	-	_	_	_	1.5	3		Vcc <sup>+</sup> =30[V],No Load	
Supply Current (All Amp)	ICC	Full range	ı	0.7	1.2	-	0.8	3	mA	Vcc <sup>+</sup> =5[V],No Load	99
		Full range	-	_	2	_	1.5	3		Vcc <sup>+</sup> =30[V],No Load	
Input Common-mode Voltage Range	VICM	25°C	_	_	Vcc <sup>+</sup> -1.5	_	_	Vcc <sup>+</sup> -1.5	V	Vcc <sup>+</sup> =30[V]	98
input Common-mode voltage Range	VICIVI	Full range	1	_	Vcc <sup>+</sup> -2.0	-	_	Vcc <sup>+</sup> -2.0	v	VCC -30[V]	96
Common-mode Rejection Ratio	CMR	25°C	70	85	_	70	80	_	dB	RS≦10[kΩ]	98
Common-mode Rejection Ratio	CIVIT	Full range	60	_	_	60	_	_	uБ	NO = 10[K12]	90
Output Short Circuit Current (*2)	Isource	25°C	20	40	60	20	40	70	mA	Vcc <sup>+</sup> =15[V],VO=+2[V] VID=+1[V]	99
Output Sink Current (*2)	Isink	25°C	10	20	_	10	20	_	mA	VO=+2[V], Vcc <sup>+</sup> =15[V],VID=-1[V]	99
, , ,			12	50	_	12	50	_	μA	VO=+0.2[V], Vcc <sup>+</sup> =15[V],VID=-1[V]	
Output Voltage Swing	Vonn	25°C	0	_	Vcc <sup>+</sup> -1.5	0	_	Vcc <sup>+</sup> -1.5	V	RL=2[kΩ]	99
Output Voltage Swing	Vopp	Full range	0	_	Vcc <sup>+</sup> -2.0	0	_	Vcc <sup>+</sup> -2.0	٧	RL-2[K12]	99
High Level Output Voltage	VOH	25°C	27	28	_	27	28	_	V	Vcc <sup>+</sup> =30[V],RL=10[kΩ]	99
Thigh Level Output Voltage	VOIT	Full range	27	_	_	27	_	_	٧	VCC -50[V],IXE-10[K22]	33
Low Level Output Voltage	VOL	25°C	_	5	20	-	5	20	mV	RL=10[kΩ]	99
. 5		Full range	-	_	20	_	-	20			
Slew Rate	SR	25°C	-	0.3	_	-	0.3	_	V/µs	RL=2[kΩ],CL=100[pF], Vcc <sup>+</sup> =15[V] VI=0.5[V] to 3[V], Unity Gain	99
Gain Bandwidth Product	GBP	25°C	-	0.6	-	_	0.6	_	MHz	Vcc <sup>f</sup> =30[V],RL=2[kΩ], CL=100[pF] VIN=10[mV],f=100[kHz]	99
Total Harmonic Distortion	THD	25°C	_	0.02	-	_	0.015	_	%	f=1[kHz],AV=20[dB] RL=2[kΩ] CL=100[pF],VO=2[Vpp]	99
Input Equivalent Noise Voltage	en	25°C	ı	<mark>40</mark>	_	_	40	_	nV/√Hz	f=1[kHz],RS=100[Ω] Vcc <sup>+</sup> =30[V]	99
Input Offset Voltage Drift	DVIO	_	1	7	_	_	7	_	μV/°C	_	_
Input Offset Current Drift	DIIO	_	-	10	_	_	10	_	pA/°C	_	_
Channel Separation	VO1/VO2	25°C	١	120	_	_	120	_	dB	1[kHz]≦f≦20[kHz]	99
	1			1	1		1	1	l	1	1

<sup>(\*1)</sup> Absolute value

<sup>(\*2)</sup> Under high temperatures, please consider the power dissipation when selecting the output current.

When output terminal is continuously shorted the output current reduces the internal temperature by flushing.

OLM2904,LM2902 family(Unless otherwise specified, Vcc+=+5[V], Vcc-=0[V])

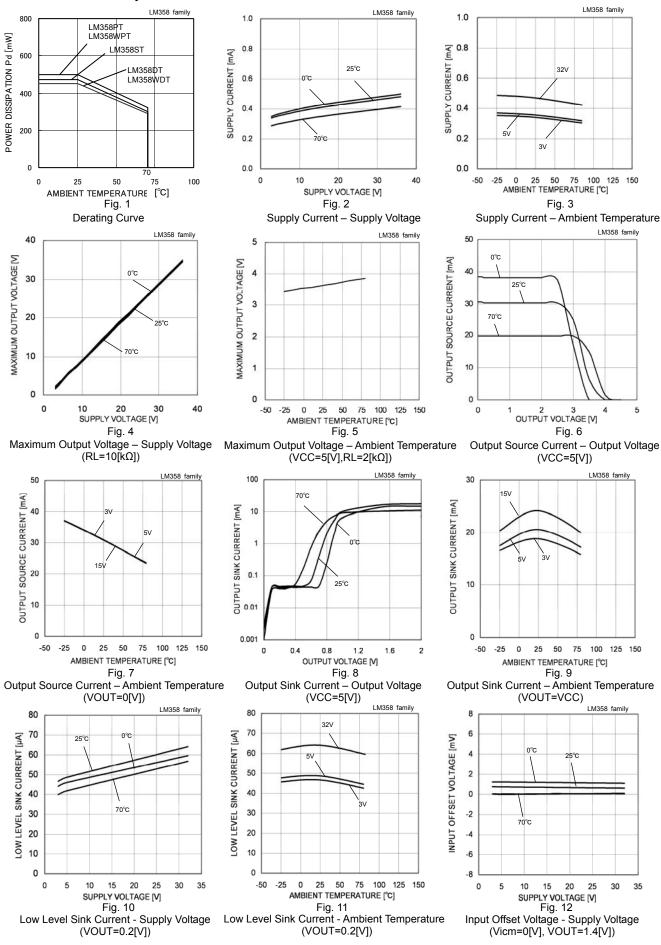
		Temperature			Lim						Fig.
Parameter	Symbol	range	Min.	12904 fai Typ.	mily Max.	Min.	//12902 fai	mily Max.	Unit	Conditions	No
		25°C	- IVIII I.	1 yp.	7	- IVIII 1.	2 2	7			
Input Offset Voltage (*3)	VIO	Full range		_	9		_	9	mV	VO=1.4[V]	98
		25°C		2	50		2	30			
Input Offset Current (*3)	IIO	Full range		_	200		_	200	nA	VO=1.4[V]	98
		25°C	_	20	150	_	20	150			
Input Bias Current (*3)	IIB	Full range	_	_	200	_	_	300	nA	VO=1.4[V]	98
Large Signal Voltage Gain	AVD	25°C	25	100	_	25	100	_	V/mV	Vcc <sup>+</sup> =15[V] VO=1.4[V] to 11.4[V] RL=2[kΩ]	98
0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0) (D	25°C	65	100	_	65	110	_			
Supply Voltage Rejection Ratio	SVR	Full range	65	_	_	65	_	_	dB	RS≦10[kΩ]	99
		25°C	_	0.7	1.2	_	0.7	1.2		Vcc <sup>+</sup> =5[V],No Lord	
0 1 . 0 1 (All A )	100	25°C	-	-	_	_	1.5	3		Vcc <sup>+</sup> =30[V],No Lord	-00
Supply Current (All Amp)	ICC	Full range	_	_	2	_	8.0	1.2	mA	Vcc <sup>+</sup> =5[V],No Lord	99
		Full range	_	_	_	_	1.5	3		Vcc <sup>+</sup> =30[V],No Lord	
Innut Common made Valtage Dange	VICM	25°C	_	_	Vcc <sup>+</sup> -1.5	_	_	Vcc <sup>+</sup> -1.5	٧	Vcc <sup>+</sup> =30[V]	00
Input Common-mode Voltage Range	VICIVI	Full range	_	_	Vcc⁺-2.0	_	_	Vcc⁺-2.0	>	VCC =30[V]	98
Common-mode Rejection Ratio	CMR	25°C	70	85	_	70	80	-	dB	RS=10[kΩ]	98
Common-mode Rejection Ratio	CIVIT	Full range	60	_	_	60	_	-	d	N3=10[K22]	90
Output Short Circuit Current (*4)	Isource	25°C	20	40	60	20	40	70	mA	Vcc <sup>+</sup> =+15[V],VO=+2[V] VID=+1[V]	98
Output Sink Current (*4)	Isink	25°C	10	20	_	10	20	_	mA	VO=2[V],Vcc <sup>+</sup> =+5[V] VID=-1[V] VO=+0.2[V],	99
			12	50	_	12	50	_	μΑ	VC=+0.2[V], Vcc <sup>+</sup> =+15[V],VID=-1[V]	
Output Voltage Swing	Vopp	25°C	0	_	Vcc⁺-1.5	_	_	_	V	RL=2[kΩ]	99
Output voltage Swing	<b>УОРР</b>	Full range	0	_	Vcc <sup>+</sup> -2.0	_	_	_	٧	NL-Z[NIZ]	33
High Level Output Voltage	VOH	25°C	27	<mark>28</mark>	_	27	28	-	V	Vcc <sup>+</sup> =30[V],RL=10[kΩ]	99
Thigh 2010 Output Voltago	7011	Full range	27	-	_	27	-	-	·	Vcc <sup>+</sup> =30[V],RL=10[kΩ]	00
Low Level Output Voltage	VOL	25°C	-	5	20	_	5	20	mV	RL=10[kΩ]	99
		Full range	_	_	20	_	-	20			
Slew Rate	SR	25°C	-	0.3	_	_	0.3	_	V/µs	RL=2[k $\Omega$ ],CL=100[pF], Unity Gain VI=0.5[V] to 3[V] Vcc <sup>+</sup> =15[V]	99
Gain Bandwidth Product	GBP	25°C	_	0.6	_	_	0.6	_	MHz	Vcc <sup>+</sup> =30[V],RL=2[kΩ] CL=100[pF] VIN=10[mV]	99
Total Harmonic Distortion	THD	25°C	_	0.02	_	_	0.015	_	%	f=1[kHz],AV=20[dB] RL=2[kΩ] CL=100[pF], Vcc*=30[V],VO=2[Vpp]	99
Input Equivalent Noise Voltage	en	25°C	_	40	_	_	40		nV/ <b>√</b> Hz	f=1[kHz],RS=100[Ω] Vcc <sup>+</sup> =30[V]	99
Input Offset Voltage Drift	DVIO	_	_	7	_	_	7	_	μV/°C	-	_
Input Offset Current Drift	DIIO	-	-	10	_	_	10	_	pA/°C	-	-
Channel Separation	VO1/VO2	25°C	_	120	_	-	120	-	dB	1[kHz]≦f≦20[kHz]	99

<sup>(\*3)</sup> Absolute value

<sup>(\*4)</sup> Under high temperatures, please consider the power dissipation when selecting the output current.

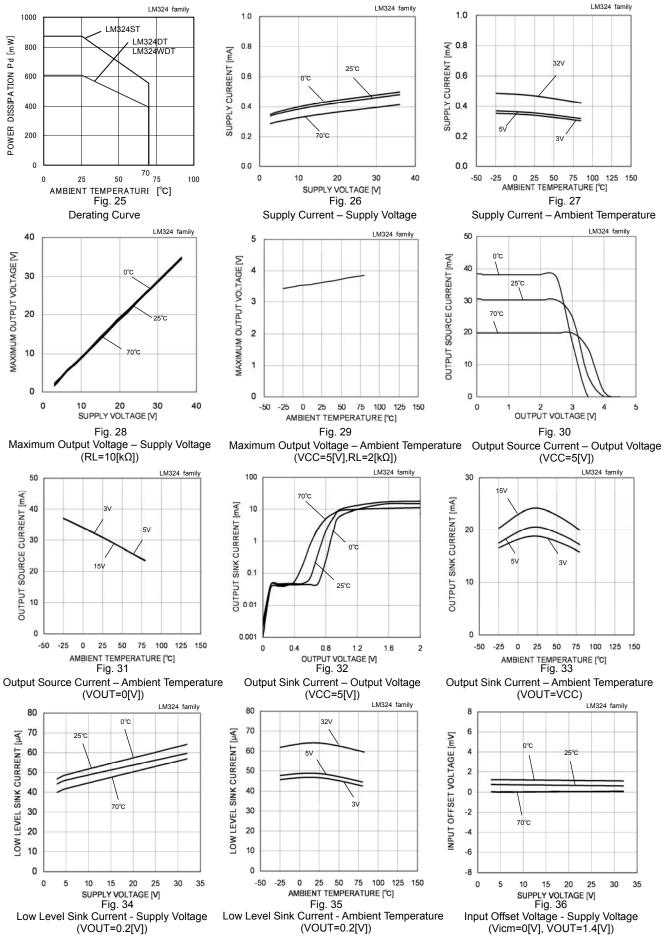
When the output terminal is continuously shorted the output current reduces the internal temperature by flushing.

### ● Reference Data LM358 family

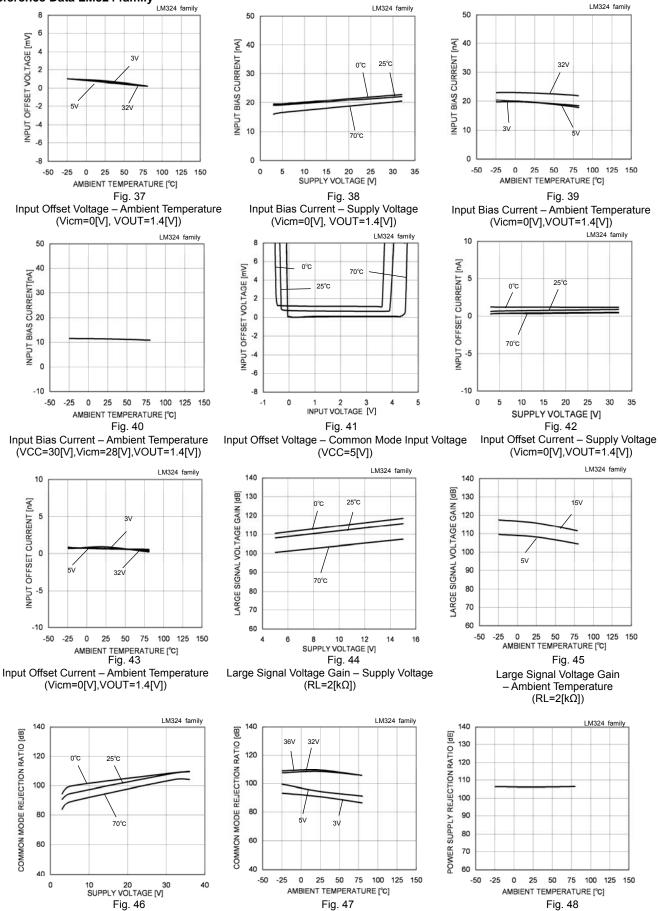


#### ●Reference Data LM358 family LM358 family LM358 family 50 50 6 INPUT OFFSET VOLTAGE [mV] INPUT BIAS CURRENT [nA] 40 INPUT BIAS CURRENT [nA] 40 4 3V 32V 25°C 2 30 30 0 20 20 -2 32V 10 10 70°C -6 0 -50 0 25 50 75 100 125 150 10 15 20 25 SUPPLY VOLTAGE [V] -50 -25 0 25 50 75 100 125 150 0 5 AMBIENT TEMPERATURE [°C] AMBIENT TEMPERATURE [°C] Fig. 13 Fig. 14 Fig. 15 Input Offset Voltage – Ambient Temperature Input Bias Current - Supply Voltage Input Bias Current - Ambient Temperature (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) LM358 family LM358 family 10 50 INPUT OFFSET CURRENT [nA] INPUT BIAS CURRENT[nA] INPUT OFFSET VOLTAGE [mV] 70°C 25°C 0°C 2 0 0 -2 ٥ -10 -10 50 75 100 125 150 0 5 15 20 25 30 35 -50 -25 0 25 0 1 2 3 INPUT VOLTAGE [V] 10 AMBIENT TEMPERATURE [°C] SUPPLY VOLTAGE [V] Fig. 16 Fig. 17 Fig. 18 Input Bias Current - Ambient Temperature Input Offset Voltage - Common Mode Input Voltage Input Offset Current - Supply Voltage (VCC=30[V],Vicm=28[V],VOUT=1.4[V]) (VCC=5[V]) (Vicm=0[V], VOUT=1.4[V]) LM358 family LM358 family 140 140 g B [dB] 130 130 INPUT OFFSET CURRENT [nA] 0°C 25°C 15V GAIN LARGE SIGNAL VOLTAGE GAIN 120 120 LARGE SIGNAL VOLTAGE 110 110 100 0 100 5V 90 90 32V 70°C 80 -5 80 70 70 -10 60 5 0 25 50 75 100 125 150 AMBIENT TEMPERATURE [°C] -50 -50 -25 25 50 75 100 125 150 8 10 12 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] Fig. 19 Fig. 20 Fig. 21 Input Offset Current Large Signal Voltage Gain Large Signal Voltage Gain - Supply Voltage (RL=2[kΩ]) - Ambient Temperature - Ambient Temperature (Vicm=0[V], VOUT=1.4[V]) $(RL=2[k\dot{\Omega}])$ LM358 family LM358 family 140 COMMON MODE REJECTION RATIO [dB] 36V 32V COMMON MODE REJECTION RATIO [dB] POWER SUPPLY REJECTION RATIO [dB] 130 120 120 25°C 120 110 100 100 100 80 80 90 3V 80 60 60 70 40 50 75 100 125 150 -50 50 75 100 125 150 -50 0 25 0 10 20 30 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] AMBIENT TEMPERATURE [°C] Fig. 23 Fig. 22 Fig. 24 Common Mode Rejection Ratio Common Mode Rejection Ratio Power Supply Rejection Ratio Supply Voltage Ambient Temperature Ambient Temperature

### ● Reference Data LM324 family



### ● Reference Data LM324 family



(\*)The data above is ability value of sample, it is not guaranteed.

Common Mode Rejection Ratio

- Supply Voltage

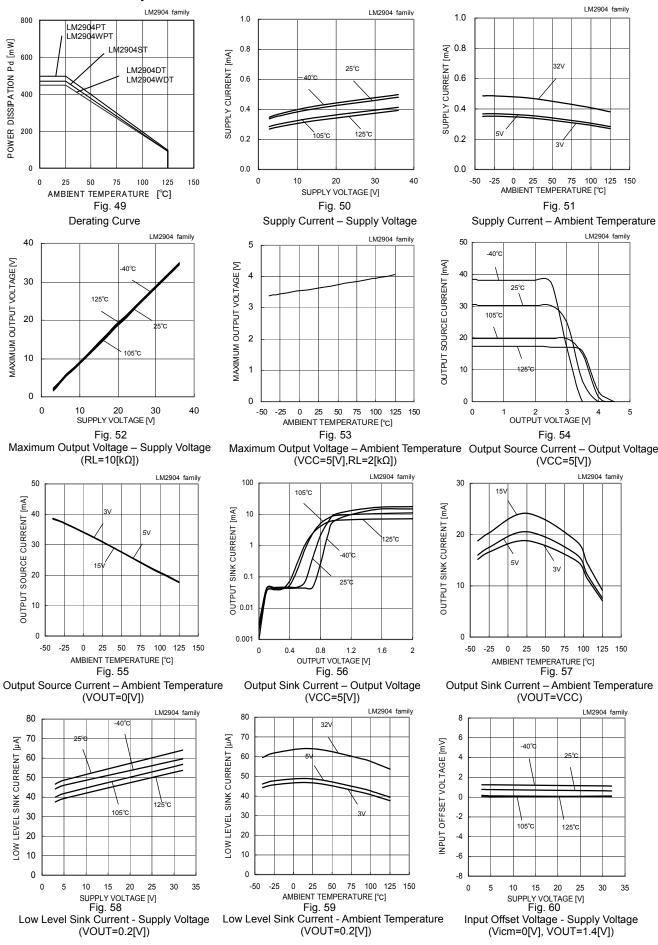
Common Mode Rejection Ratio

Ambient Temperature

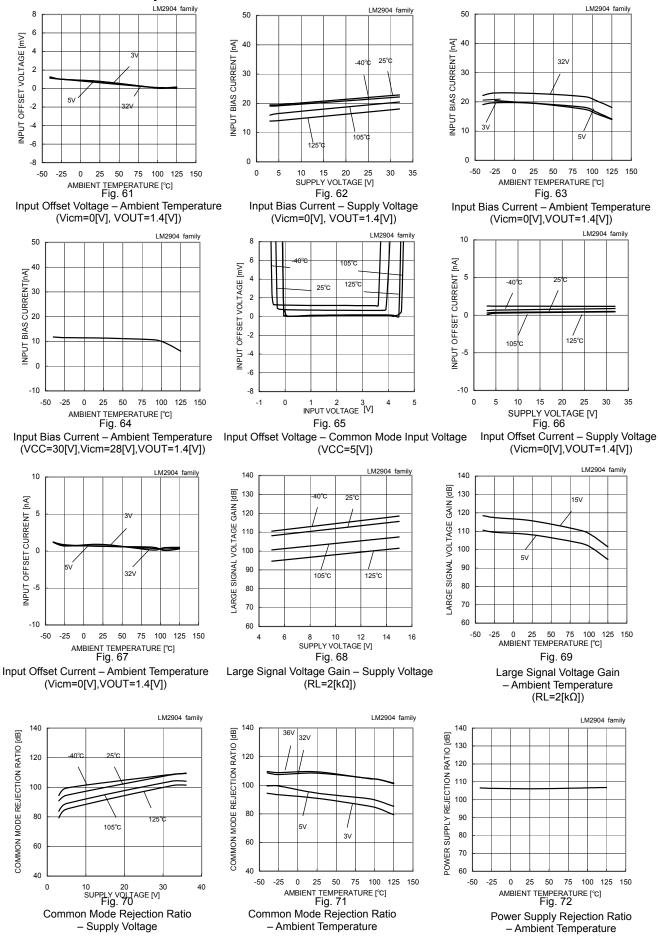
Power Supply Rejection Ratio

Ambient Temperature

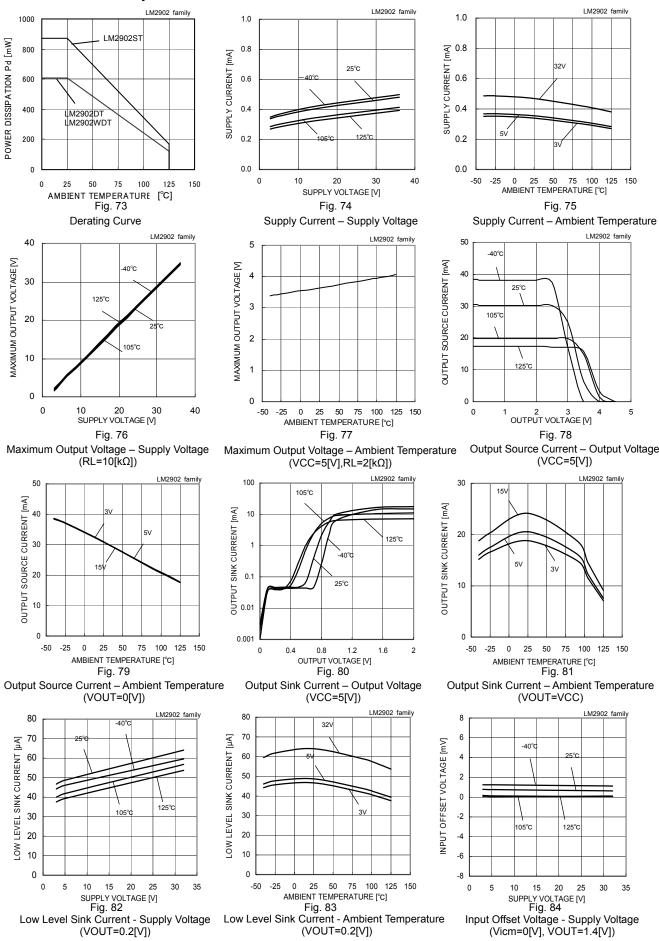
### ● Reference Data LM2904 family



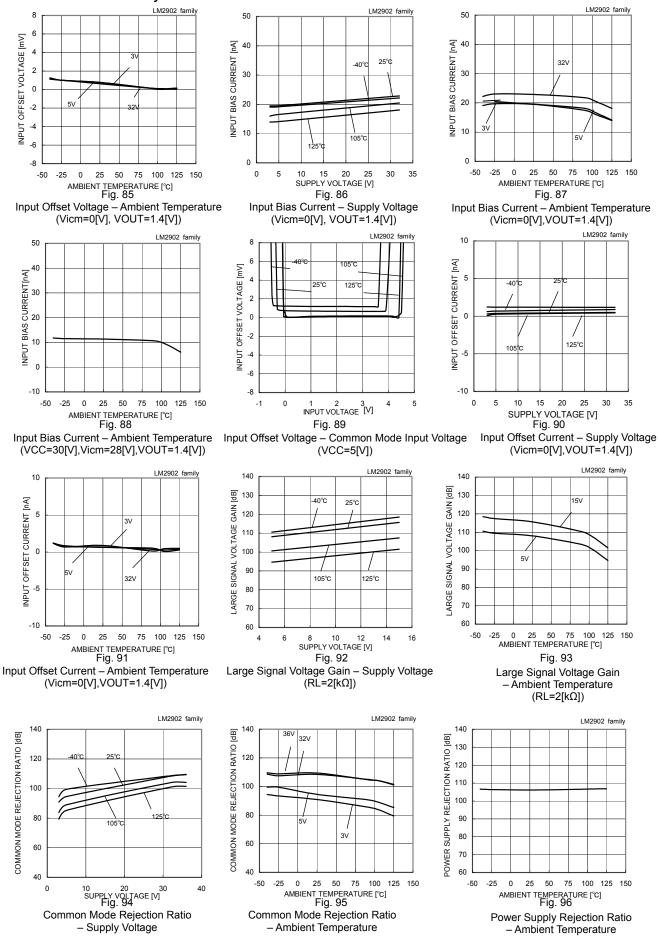
### ● Reference Data LM2904 family



### ● Reference Data LM2902 family



### ● Reference Data LM2902 family



### **●Circuit Diagram**

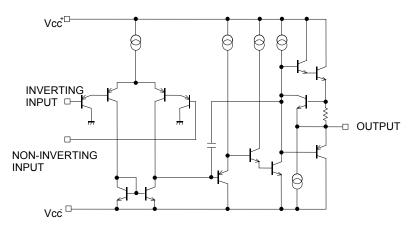


Fig.97 Circuit Diagram (each Op-Amp)

### Measurement Circuit 1 NULL Method Measurement Condition

Vcc<sup>+</sup>, Vcc<sup>-</sup>, EK, Vicm Unit: [V]

Parameter	VF	S1	S1 S2 S3		LM	358/LM	324 faı	mily	LM29	904/LM	12902 fa	amily	Calculation
Farameter	VF	31	32	33	Vcc+	Vcc-	EK	Vicm	Vcc+	Vcc-	EK	Vicm	Calculation
Input Offset Voltage	VF1	ON	ON	OFF	5 to 30	0	-1.4	0	5 to 30	0	-1.4	0	1
Input Offset Current	VF2	OFF	OFF	OFF	5	0	-1.4	0	5	0	-1.4	0	2
Input Bias Current	VF3	OFF	ON	OFF	5	0	-1.4	0	5	0	-1.4	0	3
Imput Bias Current	VF4	ON	OFF	OFF	5	0	-1.4	0	5	0	-1.4	0	3
Large Signal Voltage Gain	VF5	ON	ON	ON	15	0	-1.4	0	15	0	-1.4	0	4
Large Signal Voltage Gain	VF6	OIN	OIN	ON	15	0	-11.4	0	15	0	-11.4	0	4
Common-mode Rejection Ratio	VF7	ON	ON	OFF	5	0	-1.4	0	5	0	-1.4	0	5
Common-mode Rejection Ratio	VF8	OIN	OIN	OFF	5	0	-1.4	3.5	5	0	-1.4	3.5	3
Supply Voltage Rejection Ratio	VF9	ON	ON	OFF	5	0	-1.4	0	5	0	-1.4	0	6
Supply Voltage Rejection Ratio	VF10	ON	ON	OFF	30	0	-1.4	0	30	0	-1.4	0	U

### -Calculation-

1. Input Offset Voltage (VIO)

Vio = 
$$\frac{|VF1|}{1 + Rf/Rs}$$
 [V]

2. Input Offset Current (IIO)

lio = 
$$\frac{|VF2 - VF1|}{Ri(1+Rf/Rs)}[A]$$

3. Input Bias Current (IIB)

Ib = 
$$\frac{|VF4 - VF3|}{2 \times Ri (1 + Rf / Rs)}$$
 [A]

4. Large Signal Voltage Gain (AVD)

$$AV = 20 \times Log \frac{10 \times (1 + Rf/Rs)}{|VF6 - VF5|} [dB]$$

5.Common-mode Rejection Ration (CMRR)

CMRR = 
$$20 \times \text{Log} \ \frac{3.5 \times (1 + \text{Rf/-Rs})}{|VF8-VF7|} \ [dB]$$

6. Supply Voltage Rejection Ration (SVR)

$$PSRR = 20 \times Log \frac{\Delta Vcc^{+}\times (1+Rf/Rs)}{VF10 - VF9} [dB]$$

∆Vcc+=25V

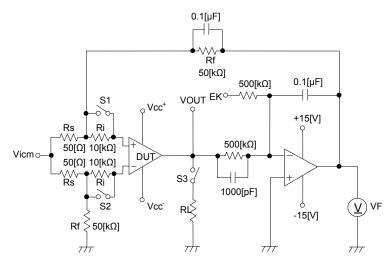
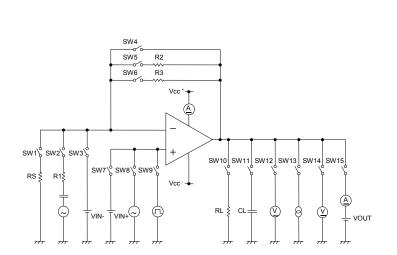


Fig.98 Measurement circuit1 (Each Op-Amps)

### Measurement circuit2 Switch condition

SW No.	SW 1	SW 2	SW 3	SW 4	SW 5	SW 6	SW 7	SW 8	SW 9	SW 10	SW 11	SW 12	SW 13	SW 14	SW 15
Supply Current	OFF	OFF	OFF	ON	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
High level Output Voltage	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF
Low level Output Voltage	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
Output source current	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON
Output sink current	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON
Slew Rate	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	ON	ON	ON	OFF	OFF	OFF	OFF
Gain band width product	OFF	ON	OFF	OFF	OFF	ON	ON	OFF	OFF	ON	ON	OFF	OFF	OFF	OFF
Equivalent input noise voltage	ON	OFF	OFF	OFF	ON	OFF	ON	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF



Input voltage 3[V]0.5[V]

Input waveform

Output voltage  $SR = \Delta V / \Delta t$  3[V]Output  $\Delta t$ Output waveform

Fig.99 Measurement circuit2 (Each Op-Amps)

Fig.100 Slew Rate Input Waveform

### ●Measurement Circuit3 Channel Separation

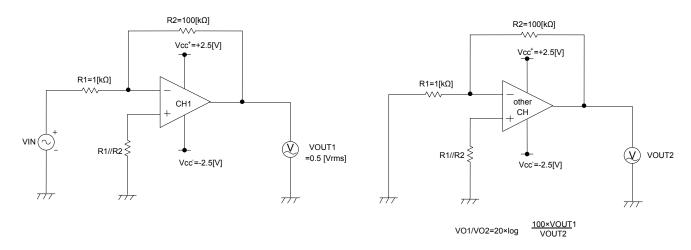


Fig.101 Measurement Circuit3

#### Description of Electrical Characteristics

Described below are descriptions of the relevant electrical terms

Please note that item names, symbols and their meanings may differ from those on another manufacturer's documents.

1. Absolute maximum ratings

The absolute maximum ratings are values that should never be exceeded, since doing so may result in deterioration of electrical characteristics or damage to the part itself as well as peripheral components.

#### 1.1 Power supply voltage (Vcc<sup>+</sup>/Vcc<sup>-</sup>)

Expresses the maximum voltage that can be supplied between the positive and negative supply terminals without causing deterioration of the electrical characteristics or destruction of the internal circuitry.

#### 1.2 Differential input voltage (VID)

Indicates the maximum voltage that can be supplied between the non-inverting and inverting terminals without damaging the IC.

#### 1.3 Input common-mode voltage range (VICM)

Signifies the maximum voltage that can be supplied to non-inverting and inverting terminals without causing deterioration of the characteristics or damage to the IC itself. Normal operation is not guaranteed within the common-mode voltage range of the maximum ratings - use within the input common-mode voltage range of the electric characteristics instead

#### 1.4 Operating and storage temperature ranges (Topr,Tstg)

The operating temperature range indicates the temperature range within which the IC can operate. The higher the ambient temperature, the lower the power consumption of the IC. The storage temperature range denotes the range of temperatures the IC can be stored under without causing excessive deterioration of the electrical characteristics.

#### 1.5 Power dissipation (Pd)

Indicates the power that can be consumed by a particular mounted board at ambient temperature (25°C). For packaged products, Pd is determined by the maximum junction temperature and the thermal resistance

#### 2. Electrical characteristics

#### 2.1 Input offset voltage (VIO)

Signifies the voltage difference between the non-inverting and inverting terminals. It can be thought of as the input voltage difference required for setting the output voltage to 0 V.

#### 2.2 Input offset voltage drift (DVIO)

Denotes the ratio of the input offset voltage fluctuation to the ambient temperature fluctuation.

Indicates the difference of input bias current between the non-inverting and inverting terminals.

#### 2.4 Input offset current drift (DIIO)

Signifies the ratio of the input offset current fluctuation to the ambient temperature fluctuation.

#### 2.5 Input bias current (IIB)

Denotes the current that flows into or out of the input terminal, it is defined by the average of the input bias current at the non-inverting terminal and the input bias current at the inverting terminal.

### 2.6 Circuit current (ICC)

Indicates the current of the IC itself that flows under specified conditions and during no-load steady state.

2.7 High level output voltage/low level output voltage (VOH/VOL)
Signifying the voltage range that can be output under specified load conditions, it is in general divided into high level output voltage and low level output voltage. High level output voltage indicates the upper limit of the output voltage, while low level output voltage the lower limit.

### 2.8 Large signal voltage gain (AVD)

The amplifying rate (gain) of the output voltage against the voltage difference between non-inverting and inverting terminals, it is (normally) the amplifying rate (gain) with respect to DC voltage.

AVD = (output voltage fluctuation) / (input offset fluctuation)

#### 2.9 Input common-mode voltage range (VICM)

Indicates the input voltage range under which the IC operates normally.

#### 2.10 Common-mode rejection ratio (CMRR)

Signifies the ratio of fluctuation of the input offset voltage when the in-phase input voltage is changed (DC fluctuation).

CMRR = (change in input common-mode voltage) / (input offset fluctuation)

### 2.11 Power supply rejection ratio (SVR)

Denotes the ratio of fluctuation of the input offset voltage when supply voltage is changed (DC fluctuation).

SVR = (change in power supply voltage) / (input offset fluctuation)

## 2.12 Output source current/ output sink current (IOH/IOL)

The maximum current that can be output under specific output conditions, it is divided into output source current and output sink current. The output source current indicates the current flowing out of the IC, and the output sink current the current flowing into the IC.

### 2.13 Channel separation (VO1/VO2)

Expresses the amount of fluctuation of the input offset voltage or output voltage with respect to the change in the output voltage of a driven channel.

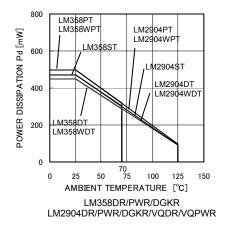
#### 2.14 Slew rate (SR)

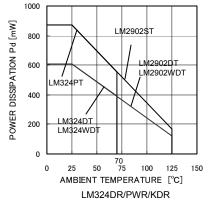
Indicates the time fluctuation ratio of the output voltage when an input step signal is supplied

### 2.15 Gain bandwidth product (GBP)

The product of the specified signal frequency and the gain of the op-amp at such frequency, it gives the approximate value of the frequency where the gain of the op-amp is 1 (maximum frequency, and unity gain frequency).

### Derating curves





LM324DR/PWR/KDR LM2902DR/PWR/KDR/KPWR/KQDR/KQPWR

### Power Dissipation

Package	Pd[W]	θ ja [°C/W]
SO package8 (*8)	450	3.6
TSSOP8 (*6)	500	4.0
Mini SO8 (*7)	470	3.76

Power Dissipation

Package	Pd[W]	θ ja [°C/W]
SO package14	610	4.9
TSSOP14	870	7.0

Fig.102 Derating Curves

### Precautions

#### 1) Unused circuits

When there are unused circuits, it is recommended that they be connected as in Fig.103, setting the non-inverting input terminal to a potential within the in-phase input voltage range (VICM).

#### 2) Input terminal voltage

Applying Vcc $^{\circ}$  +  $32\overline{\mathrm{V}}$  to the input terminal is possible without causing deterioration of the electrical characteristics or destruction, irrespective of

the supply voltage. However, this does not ensure normal circuit operation. Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.

### 3) Power supply (single / dual)

The op-amp operates when the voltage supplied is between Vcc\* and Vcc. Therefore, the single supply op-mp can be used as a dual supply op-amp as well.

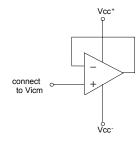


Fig.103 Disable circuit example

#### 4) Power dissipation (Pd)

Using the unit in excess of the rated power dissipation may cause deterioration in electrical characteristics due to the rise in chip temperature, including reduced current capability. Therefore, please take into consideration the power dissipation (Pd) under actual operating conditions and apply a sufficient margin in thermal design. Refer to the thermal derating curves for more information.

## 5) Short-circuit between pins and erroneous mounting

Incorrect mounting may damage the IC. In addition, the presence of foreign substances between the outputs, the output and the power supply, or the output and Vcc may result in IC destruction.

### 6) Operation in a strong electromagnetic field

Operation in a strong electromagnetic field may cause malfunctions.

#### 7) Radiation

This IC is not designed to withstand radiation.

#### 8) IC handing

Applying mechanical stress to the IC by deflecting or bending the board may cause fluctuation of the electrical characteristics due to piezoelectric (piezo) effects.

#### 9) IC operation

The output stage of the IC is configured using Class C push-pull circuits. Therefore, when the load resistor is connected to the middle potential of Vcc, and Vcc, crossover distortion occurs at the changeover between discharging and charging of the output current. Connecting a resistor between the output terminal and Vcc, and increasing the bias current for Class A operation will suppress crossover distortion.

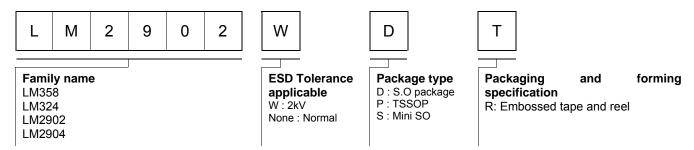
#### 10) Board inspection

Connecting a capacitor to a pin with low impedance may stress the IC. Therefore, discharging the capacitor after every process is recommended. In addition, when attaching and detaching the jig during the inspection phase, ensure that the power is turned OFF before inspection and removal. Furthermore, please take measures against ESD in the assembly process as well as during transportation and storage.

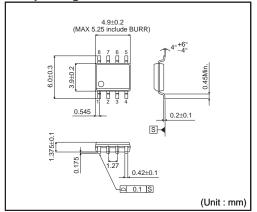
#### 11) Output capacitor

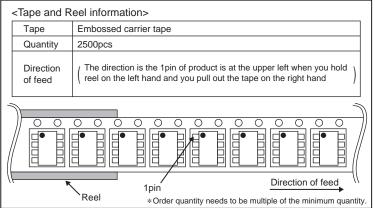
Discharge of the external output capacitor to Vcc<sup>+</sup> is possible via internal parasitic elements when Vcc<sup>+</sup> is shorted to Vcc<sup>-</sup>, causing damage to the internal circuitry due to thermal stress. Therefore, when using this IC in circuits where oscillation due to output capacitive load does not occur, such as in voltage comparators, use an output capacitor with a capacitance less than 0.1μF.

### Ordering part number

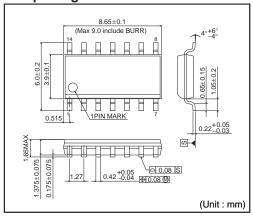


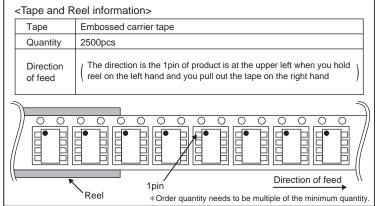
### S.O package8



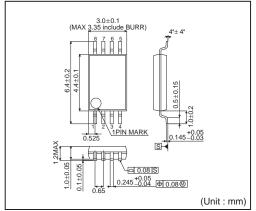


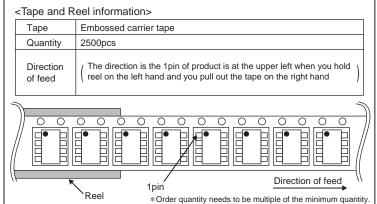
### S.O package14



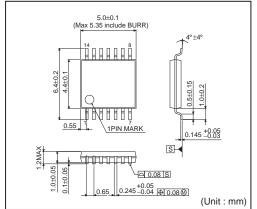


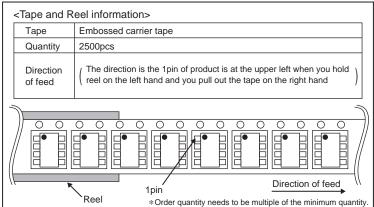
### TSSOP8



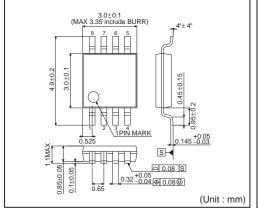


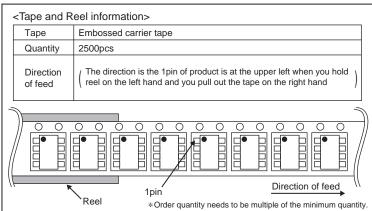
### TSSOP14





### Mini SO8





## **Notice**

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(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

### Precautions Regarding Application Examples and External Circuits

- If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

### Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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